



TRANSIENT/SURGE ABSORBER

TRANSIENT VOLTAGE SURGE SUPPRESSORS

Performance Characteristics (Mechanical)

Characteristics	Test Methods	Specifications								
Robustness of Terminations (Tensile)	<p>After gradually applying the force specified below and keeping the unit fixed for ten seconds, the terminal shall be visually examined for any damage</p> <table border="1"> <thead> <tr> <th>Terminal Diameter</th> <th>Force</th> </tr> </thead> <tbody> <tr> <td>§ 0.6mm</td> <td>9.8N(1.0 Kgf)</td> </tr> <tr> <td>§ 0.8mm</td> <td>9.8N(1.0 Kgf)</td> </tr> <tr> <td>§ 1.0mm</td> <td>19.6N(2.0 Kgf)</td> </tr> </tbody> </table>	Terminal Diameter	Force	§ 0.6mm	9.8N(1.0 Kgf)	§ 0.8mm	9.8N(1.0 Kgf)	§ 1.0mm	19.6N(2.0 Kgf)	No outstanding damage
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§ 0.8mm	9.8N(1.0 Kgf)									
§ 1.0mm	19.6N(2.0 Kgf)									
Robustness of Terminations (Bending)	<p>The unit shall be secured with its terminal kept vertical and the force specified below be applied in the axial direction. The terminal shall gradually be bent by 90° in one direction, then 90° in the opposite direction, and again back to the original position. The damage of the terminal shall be visually examined.</p> <table border="1"> <thead> <tr> <th>Terminal Diameter</th> <th>Force</th> </tr> </thead> <tbody> <tr> <td>§ 0.6mm</td> <td>4.9N(0.5 Kgf)</td> </tr> <tr> <td>§ 0.8mm</td> <td>4.9N(0.5 Kgf)</td> </tr> <tr> <td>§ 1.0mm</td> <td>9.8N(1.0 Kgf)</td> </tr> </tbody> </table>	Terminal Diameter	Force	§ 0.6mm	4.9N(0.5 Kgf)	§ 0.8mm	4.9N(0.5 Kgf)	§ 1.0mm	9.8N(1.0 Kgf)	
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Vibration	<p>After repeatedly applying a single harmonic vibration (amplitude: 0.75 mm) Double amplitude: 1.5mm with 1 minute vibration frequency cycles (10Hz to 55Hz to 10 Hz) to each of three perpendicular directions for 2 hours. Thereafter, the unit shall be visually examined.</p>									
Solderability	<p>After dipping the terminals to a depth of approximately 3 mm from the body in a soldering bath of 235 ± 5°C for 2 ± 0.5 seconds, the terminal shall be visually examined</p>	Approximately 95% of the terminals shall be covered with solder uniformly.								
Resistance to Soldering Heat	<p>Each lead shall be dipped into a solder bath at the temperature of 260 ± 5°C (3 series: 250 ± 5°C) to a point 2.0 to 2.5 mm from the body of the unit, using shielding board (t=1.5mm), be held there for specified time (3 series: 3 ± 1s, 5 series: 5 ± 1s and others: 10 ± 1s), and then be stored at room temperature and humidity for 1 to 2 hours. The change of Vc and mechanical damages are examined.</p>	$\Delta V_{CmA} / V_{CmA} \leq \pm 5\%$ No outstanding damage								